



## ATTACHMENT B Amendments to the Specification

*Please replace the paragraphs at page 7, lines 7-22, with the following amended paragraphs.*

Figure 4A shows a cooling assembly, also referred to as an isolating assembly, with an alternate passage as another embodiment of the present invention. Cooling assembly 60 is disposed within a computer case (not shown), and comprises cooling assembly wall 62 with fan 64, cooling assembly wall 66, cooling assembly wall 70 in communication with duct 72 through opening 74, and cooling assembly wall 75. Disposed within cooling assembly 60 are CPU module 76 with an attached heat sink 78. Cooling assembly walls 62, 66, 70, and 75 of isolation assembly 60 generally isolate heat generated from CPU module 76 with attached heat sink 78 from any other components ~~(not shown)~~, indicated by component 71, that are mounted on board 80. Heat sink 78 is a passive heat sink, instead of an active heat sink. As previously noted, the use of a passive heat sink results in a lower cost than the use of an active heat sink. Further, the use of this embodiment results in better cooling of the CPU than the use of only active heat sinks. Moreover, although Figure 4A shows only one CPU module 76 with attached heat sink 78, cooling assembly 60 may be used to cool more than one CPU.

A second passage in which the air travels is from opening 74 on cooling assembly wall 70, across CPU module 76 and heat sink 78, and out through fan 64 on cooling assembly wall 62. This is referred to as a second passage because another passage is defined outside of isolation assembly 60 through which air is, e.g., drawn into the computer case (not shown) by a fan such as one or more of the unnumbered fans of Figure 1.

*Please replace the paragraph at page 7, lines 27-29, with the following amended paragraph.*

Preferably, the air that is drawn from outside of the computer case that contains cooling assembly 60 and that is blown across CPU module 76 and heat sink 78 should

not mix with air in the first passage that is within the computer case but outside of isolation or cooling assembly 60.